

SM1A54NHU-VB Datasheet N-Channel 100-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) ^a | Q _g (Typ.) | |
| 100 | 0.0185 at V _{GS} = 10 V | 45 | 38 nC | |

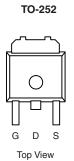
FEATURES

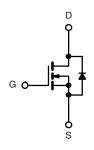
- Trench Power MOSFET
- 100 % R_g and UIS Tested





- Primary Side Switch
- Isolated DC/DC Converter





N-Channel MOSFET

| Parameter | | Symbol | Limit | Unit | |
|--|-----------------------------------|-----------------|------------------|------|--|
| Drain-Source Voltage | | V _{DS} | 100 | V | |
| Gate-Source Voltage | | V_{GS} | ± 20 | | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 25 °C | | 45 ^a | | |
| | T _C = 100 °C | | 30 | | |
| | T _A = 25 °C | I _D | 9.2 ^b | | |
| | T _A = 100 °C | | 6.8 ^b | | |
| Pulsed Drain Current | | I _{DM} | 140 | _ A | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | | 45 ^a | | |
| | T _A = 25 °C | I _S | 2 ^b | 7 | |
| Single Pulse Avalanche Current | L = 0.1 mH | I _{AS} | 35 | | |
| Avalanche Energy | L=0.1 IIII | E _{AS} | 101 | mJ | |
| Maximum Power Dissipation | T _C = 25 °C | | 136.4 | | |
| | T _C = 100 °C | ь | 68.2 | W | |
| | T _A = 25 °C | P _D | 3p | | |
| | T _A = 100 °C | | 1.5 ^b | | |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | - 55 to 175 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient ^b | Steady State | R _{thJA} | 40 | 50 | °C/W |
| Maximum Junction-to-Case | Sleady State | R _{thJC} | 0.85 | 1.1 | C/VV |

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|--|-------------------------|---|------|--------|-------|-------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 100 | | | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 250 μA | | 110 | | mV/°C |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | | | - 12.5 | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 2.5 | | 5 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zone Oata Walle as Durin Oan | I _{DSS} | V _{DS} = 100 V, V _{GS} = 0 V | 1 | | 1 | |
| Zero Gate Voltage Drain Current | | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | μΑ |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 30 | | | Α |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 15 A | | 0.0185 | | Ω |
| Forward Transconductance ^a | g _{fs} | V _{DS} = 15 V, I _D = 15 A | | 33 | | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | | | 2400 | | pF |
| Output Capacitance | C _{oss} | $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 230 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 80 | | |
| Total Gate Charge | Q_g | | | 38 | 70 | nC |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$ | | 14 | | |
| Gate-Drain Charge | Q _{gd} | | | 12 | | |
| Gate Resistance | R_g | f = 1 MHz | | 1.6 | 2.5 | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 12 | 20 | |
| Rise Time | t _r | $V_{DD} = 50 \text{ V}, R_L = 1 \Omega$ | | 10 | 20 | ns |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | | 18 | 35 | |
| Fall Time | t _f | | | 8 | 15 | |
| Drain-Source Body Diode Characteris | stics | | | | | |
| Continuous Source-Drain Diode | I _S | T _C = 25 °C | | | 35 | A |
| Pulse Diode Forward Current ^a | I _{SM} | _ | | | 100 | |
| Body Diode Voltage | V_{SD} | I _S = 15 A | | 0.85 | 1.5 | V |
| Body Diode Reverse Recovery Time t _{rr} | | | | 80 | 120 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | I _F = 50 A, dl/dt = 100 A/μs, T _J = 25 °C | | 160 | 240 | nC |
| Reverse Recovery Fall Time | t _a | | | 57 | | ns |
| Reverse Recovery Rise Time | t _b | | | 23 | | |

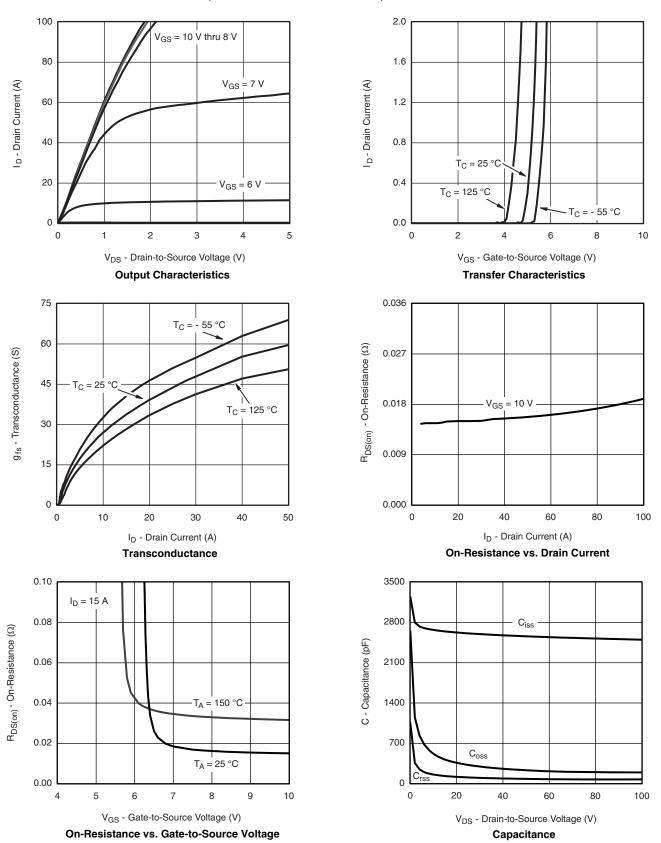
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise note)



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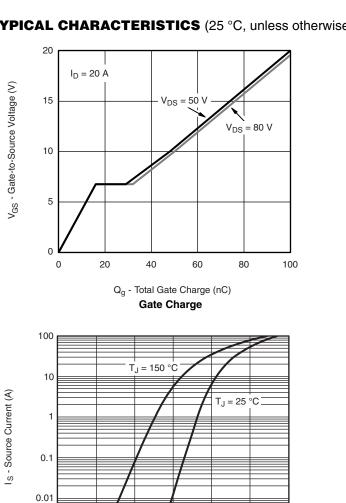
0.001

0.2

0.4



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

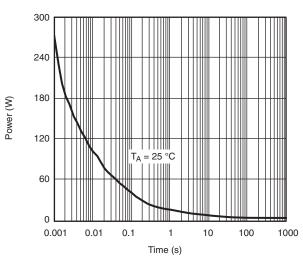


V_{SD} - Source-to-Drain Voltage (V) Source-Drain Diode Forward Voltage

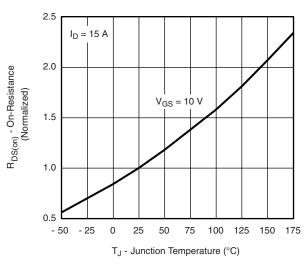
0.6

0.8

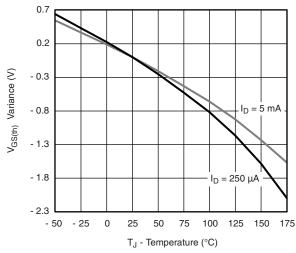
1.0



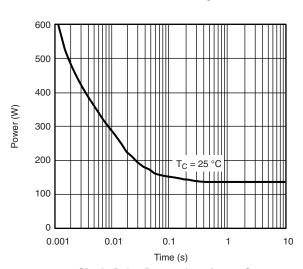
Single Pulse Power, Junction-to-Ambient



On-Resistance vs. Junction Temperature



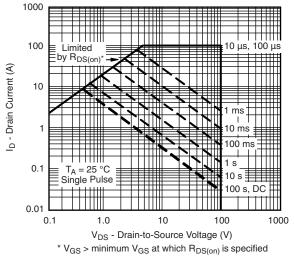
Threshold Voltage



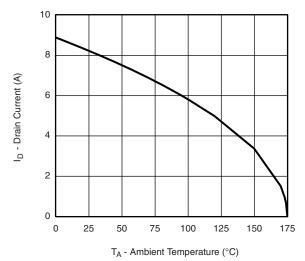
Single Pulse Power, Junction-to-Case



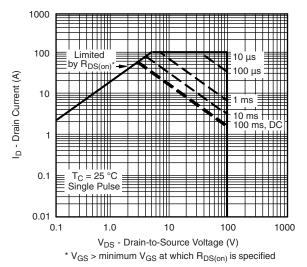
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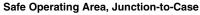


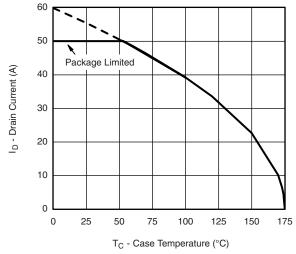




Current Derating**, Junction-to-Ambient





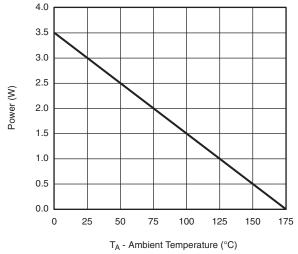


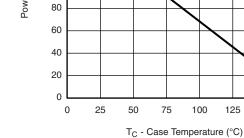
Current Derating**, Junction-to-Case

^{**} The power dissipation P_D is based on $T_{J(max.)}$ = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





180 160

140

120

100

Power Derating**, Junction-to-Ambient

Power Derating**, Junction-to-Case

100

125

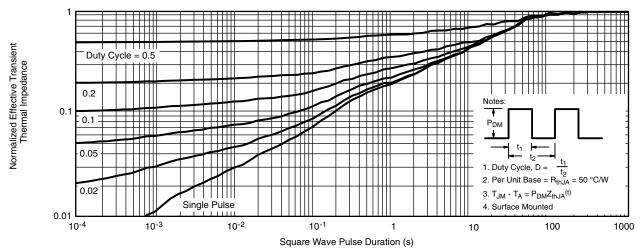
150

175

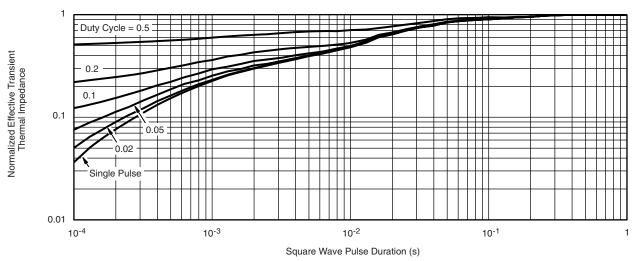
^{**} The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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